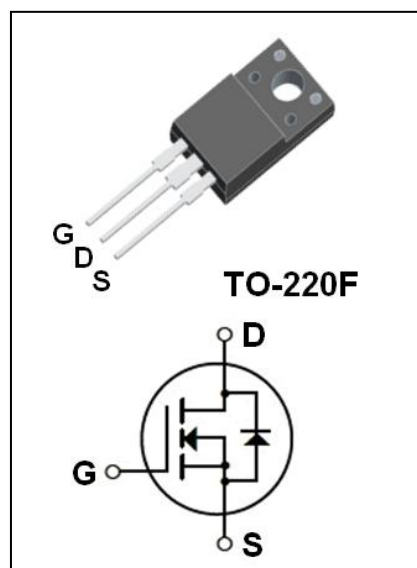


### ●Features:

- 11.0A, 650V,  $R_{DS(on)(Typ)} = 380m\Omega @ V_{GS}=10V$
- Ultra Low Gate Charge
- Ultra Low  $C_{rss}$
- 100% Avalanche Tested
- Fast Switching
- Improved dv/dt Capability

### ●Application:

- High Frequency Switching Mode Power Supply
- Active Power Factor Correction



### Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain-Source Voltage	650	V
$V_{GSS}$	Gate-Source Voltage	$\pm 30$	V
$I_D$	Drain Current	- Continuous ( $T_c=25^\circ C$ )	11.0*
		- Continuous ( $T_c=100^\circ C$ )	7.0*
$I_{DM}$	Drain Current - Pulsed (Note1)	33*	A
$P_D$	Power Dissipation ( $T_c = 25^\circ C$ ) - Derate above $25^\circ C$	32	W
		0.26	W/ $^\circ C$
$E_{AS}$	Single Pulsed Avalanche Energy (Note2)	272	mJ
$I_{AR}$	Avalanche Current (Note1)	5.5	A
$E_{AR}$	Repetitive Avalanche Energy, $t_{AR}$ limited by $T_{jmax}$ (Note1)	0.5	mJ
dv/dt	Drain Source voltage slope, $V_{DS} \leq 480V$	50	V/ns
dv/dt	Reverse diode dv/dt, $V_{DS} \leq 480V, I_{SD} \leq I_D$	15	V/ns
$T_j$	Operating Junction Temperature	150	$^\circ C$
$T_{stg}$	Storage Temperature Range	-55 to +150	$^\circ C$

\* Drain Current Limited by Maximum Junction Temperature.

### Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.9	$^\circ C / W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	80	$^\circ C / W$



# GXF65R380

## 650V N-Channel Super Junction Power MOSFET

### Electrical Characteristics (T<sub>c</sub>=25°C unless otherwise noted)

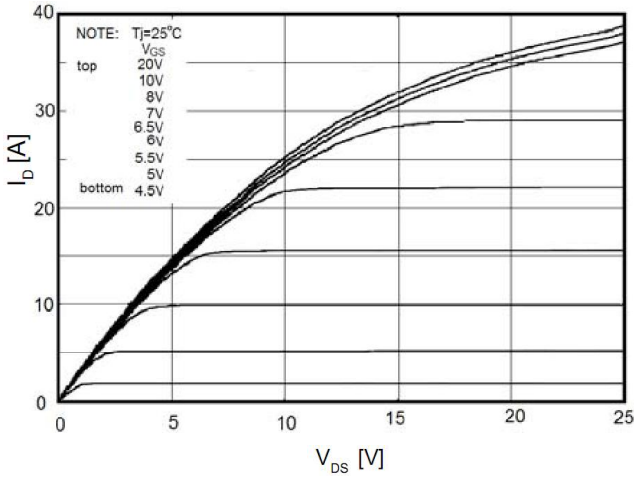
Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
BV <sub>DSS</sub>	Drain-source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	650	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V	--	--	1	μA
		V <sub>DS</sub> =650V, T <sub>c</sub> =125°C	--	--	100	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> =+30V, V <sub>DS</sub> =0V	--	--	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V	--	--	-100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2.0	--	4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10 V, I <sub>D</sub> =5.5A	--	380	420	mΩ
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =20 V, I <sub>D</sub> =5.5A	--	7.7	--	S
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V, f=1.0MHz	--	695	--	pF
C <sub>oss</sub>	Output Capacitance		--	53	--	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	2.5	--	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 480V, I <sub>D</sub> = 11 A, V <sub>GS</sub> = 10 V	--	14.5	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	3.8	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	5.3	--	nC
R <sub>G</sub>	Intrinsic gate resistance	f=1MHz open drain		1.9		Ω
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 380V, I <sub>D</sub> = 5.5 A, R <sub>G</sub> = 6.8 Ω, V <sub>GS</sub> =10 V	--	24	--	ns
t <sub>r</sub>	Turn-On Rise Time		--	24.3	--	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		--	34.2	--	ns
t <sub>f</sub>	Turn-Off Fall Time		--	36.2	--	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>SD</sub>	Maximum Continuous Drain-Source Diode Forward Current		--	--	11	A
I <sub>SDM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		--	--	33	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	T <sub>J</sub> = 25°C, V <sub>GS</sub> = 0V, I <sub>SD</sub> = 11.0A	--	--	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	T <sub>J</sub> = 25°C, I <sub>F</sub> = 11.0A, dI <sub>F</sub> / dt = 100A/μs	--	275	--	ns
Q <sub>rr</sub>	Reverse Recovery Charge		--	2.9	--	μC
I <sub>rrm</sub>	Peak Reverse Recovery Current		--	20.5	--	A

#### Notes:

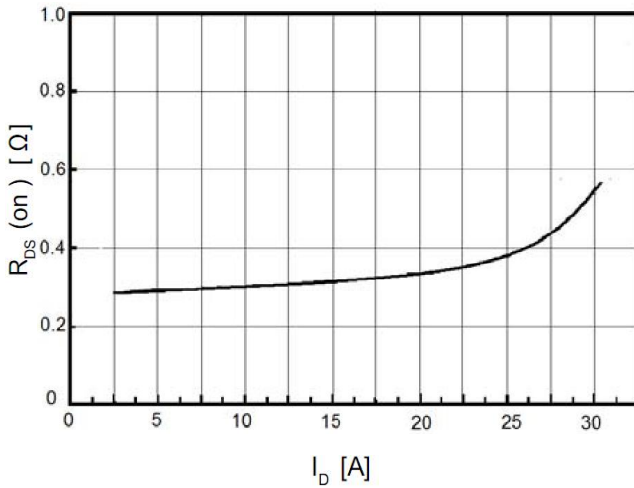
- 1、Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
- 2、T<sub>J</sub> = 25°C, V<sub>DD</sub> = 50V, V<sub>G</sub> = 10V, R<sub>G</sub> = 25 Ω.



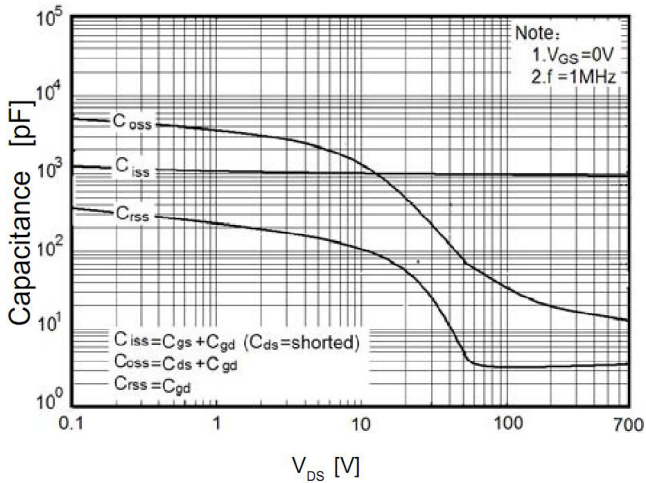
### On-Regin Characteristics



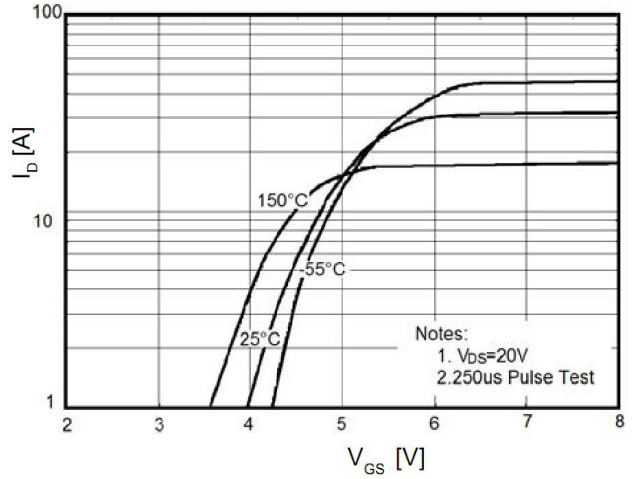
### On-Resistance Variation vs. Drain Current and Gate Voltage



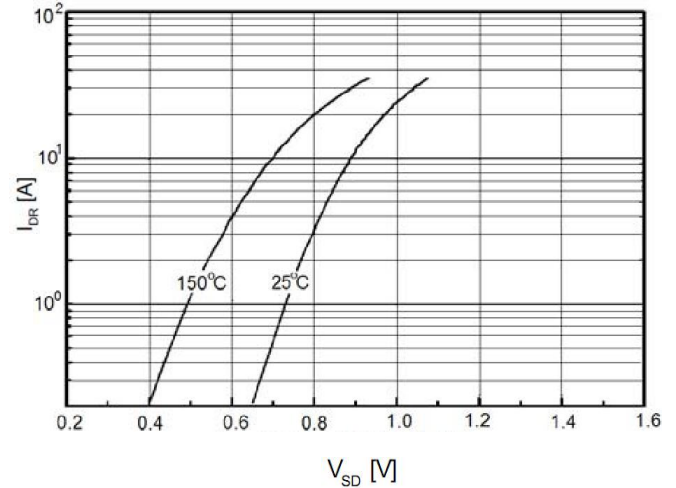
### Capacitance Characteristics



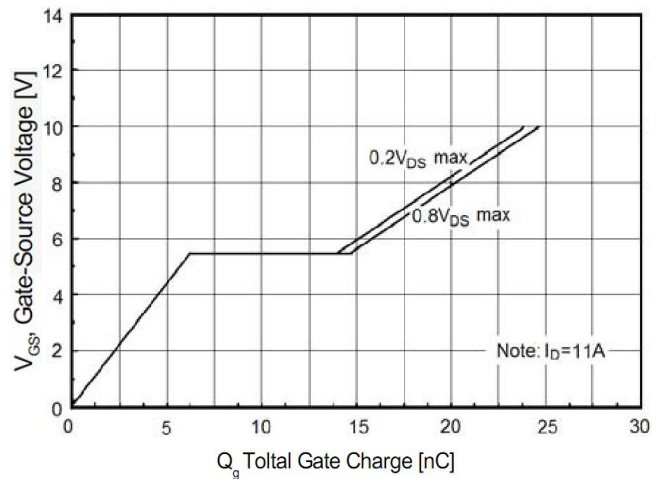
### Transfer Characteristics



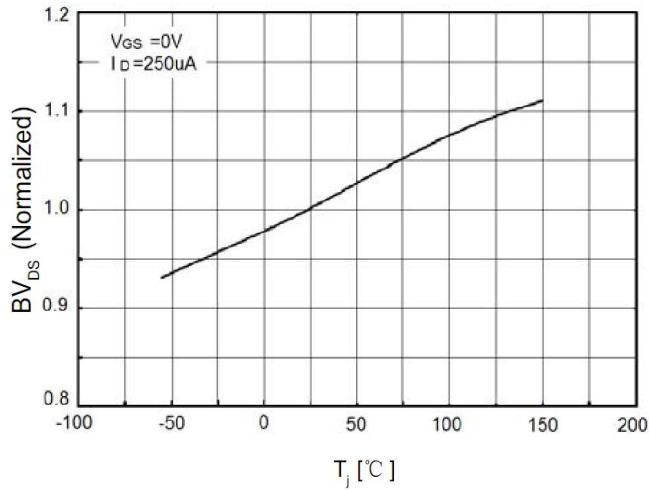
### Body Diode Forward Voltage Variation vs. Source Current and Temperature



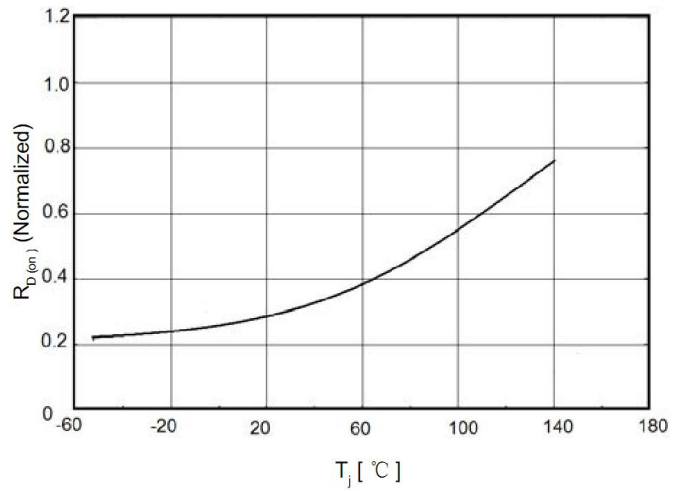
### Gate Charge Characteristics



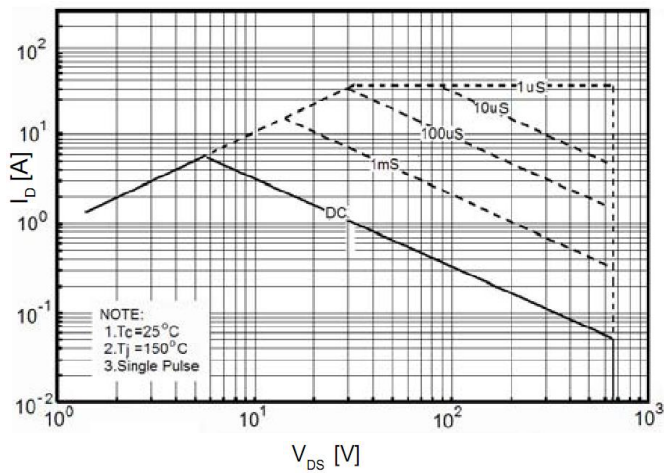
### Breakdown Voltage Variation vs. Temperature



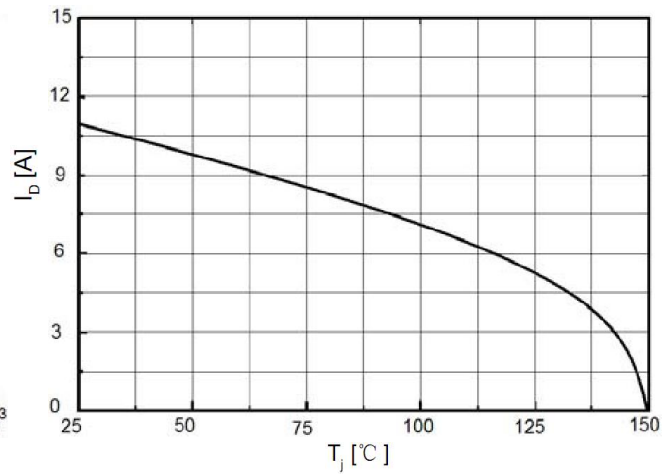
### On-Resistance Variation vs. Temperature



### Maximum Safe Operating Area



### Maximum Drain Current Vs. Case Temperature





国芯佳品半导体  
GUOXIN JIAPIN SEMICONDUCTOR

# GXF65R380

650V N-Channel Super Junction Power MOSFET

## TO-220F Package Dimensions

UNIT: mm

SYMBOL	min	nom	max	SYMBOL	min	nom	max
A	9.80		10.60	D		2.54	
A1		7.00		D1	1.15		1.55
A2	2.90		3.40	D2	0.60		1.00
A3	9.10		9.90	D3	0.20		0.50
B1	15.40		16.40	E	2.24		2.84
B2	4.35		4.95	E1		0.70	
B3	6.00		7.40	E2		1.0×45°	
C	3.00		3.70	E3	0.35		0.65
C1	15.00		17.00	E4	2.30		3.30
C2	8.80		10.80	α (度)		30°	

